



Features and Benefits

Low Input Capacitance

PPAP Capable (Note 4)

Mechanical Data

Case: SO-8

P-CHANNEL ENHANCEMENT MODE MOSFET

100% Unclamped Inductive Switch (UIS) test in production

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3) Qualified to AEC-Q101 Standards for High Reliability

Case Material: Molded Plastic, "Green" Molding Compound.

Terminals: Finish - Matte Tin Annealed over Copper Leadframe.

UL Flammability Classification Rating 94V-0 Moisture Sensitivity: Level 1 per J-STD-020

Solderable per MIL-STD-202, Method 208 @3

Terminal Connections: See Diagram

Weight: 0.074 grams (Approximate)

Product Summary

V _{(BR)DSS}	R _{DS(ON)} Max	I _D T _A = +25°C
-40V	$11m\Omega @ V_{GS} = -10V$	-10.1A
	$15m\Omega @ V_{GS} = -4.5V$	-8.8A

Description

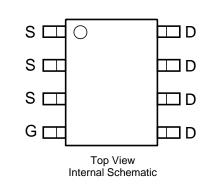
This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

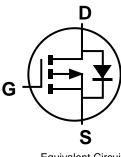
Applications

- DC-DC Converters
- Power Management Functions

SO-8

Analog Switch





Equivalent Circuit

Ordering Information (Note 5)

Top View

Part Number	Qualification	Case	Packaging
DMP4015SSSQ-13	Automotive	SO-8	2,500/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

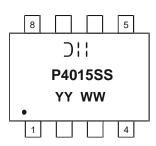
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



) :| = Manufacturer's Marking P4015SS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 13 = 2013) WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	-40	V		
Gate-Source Voltage			V _{GSS}	±25	V
Continuous Drain Current (Note 6) V_{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	ID	-9.1 -7.2	А
Continuous Drain Current (Note 6) $V_{GS} = -4.5V$	Steady State	T _A = +25°C T _A = +70°C	ID	-7.8 -6.2	А
Continuous Drain Current (Note 7) $V_{GS} = -10V$	Steady State	T _A = +25°C T _A = +70°C	ID	-10.1 -8	А
Continuous Drain Current (Note 7) V_{GS} = -4.5V	$\begin{array}{c c} Steady & T_A = +25^{\circ}C \\ State & T_A = +70^{\circ}C \end{array}$		ID	-8.8 -7	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-100	А		
Avalanche Current (Note 8)	I _{AS}	-22	A		
Avalanche Energy (Note 8)			E _{AS}	242	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 6)	PD	1.45	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	88	°C/W
Total Power Dissipation (Note 7)	PD	1.82	W
Thermal Resistance, Junction to Ambient (Note 7)	R _{0JA}	70	°C/W
Thermal Resistance, Junction to Case (Note 7)	R _{θJc}	7.6	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)					•		
Drain-Source Breakdown Voltage	BV _{DSS}	-40	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μA	$V_{DS} = -40V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_		±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(th)}	-1.5	-2	-2.5	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance		_	7	11	mΩ	$V_{GS} = -10V, I_D = -9.8A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	9	15	11152	$V_{GS} = -4.5V, I_D = -9.8A$	
Forward Transfer Admittance	Y _{fs}	_	26	_	S	$V_{DS} = -20V, I_D = -9.8A$	
Diode Forward Voltage (Note 6)	V _{SD}	_	-0.7	-1	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 10)						÷	
Input Capacitance	Ciss	_	4,234	_		$V_{DS} = -20V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	C _{oss}	_	1,036	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	526	_			
Gate Resistance	R _G	_	7.77	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	_	47.5	_			
Gate-Source Charge	Q _{gs}	_	14.2	_	nC	$V_{DS} = -20V, V_{GS} = -5V$	
Gate-Drain Charge	Q _{gd}	_	13.5	_		I _D = -9.8A	
Turn-On Delay Time	t _{D(on)}		13.2	_		$V_{GS} = -10V, V_{DD} = -20V, R_G = 6\Omega,$	
Turn-On Rise Time	tr	_	10	_	nS		
Turn-Off Delay Time	t _{D(off)}		302.7	_	115	$I_D = -1A, R_L = 20\Omega$	
Turn-Off Fall Time	tf		137.9	—]		

Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate

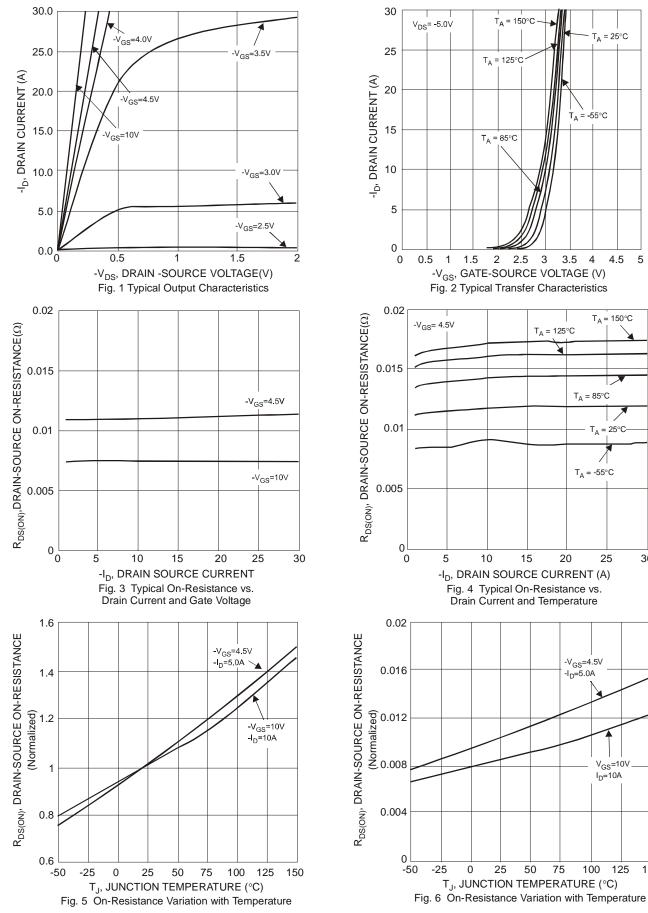
8 .UIS in production with L = 1mH, T_J = +25°C

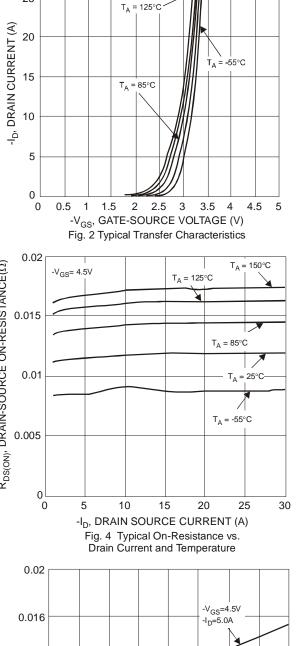
9. Short duration pulse test used to minimize self-heating effect.

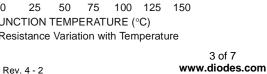
10. Guaranteed by design. Not subject to production testing.

Г_А = 25°С









150

V_{GS}=10V I_D=10A

125

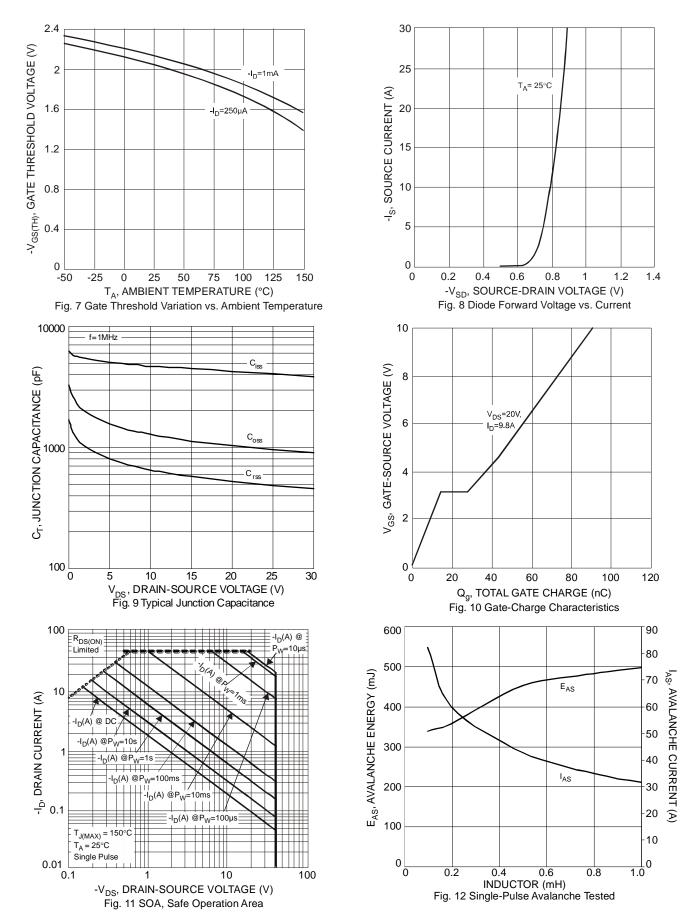
100

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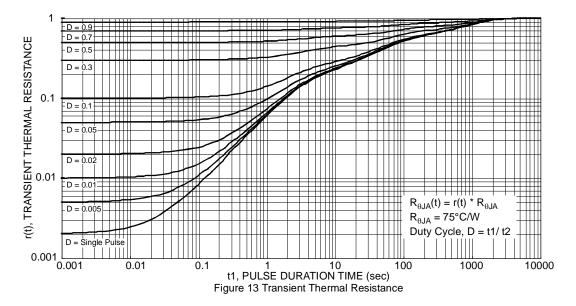
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DMP4015SSSQ Document number: DS36682 Rev. 4 - 2





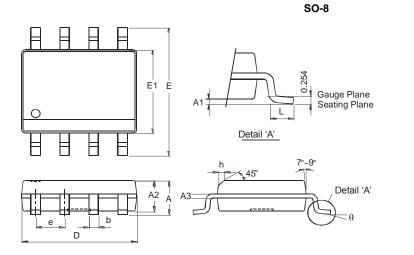






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

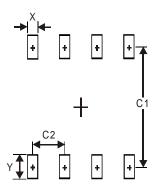


	SO-8			
Dim	Min	Max		
Α	-	1.75		
A1	0.10	0.20		
A2	1.30	1.50		
A3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
Е	5.90	6.10		
E1	3.85	3.95		
е	1.27 Тур			
h	-	0.35		
L	0.62	0.82		
θ	0°	8°		
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

SO-8



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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